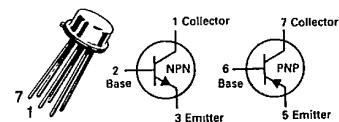


MD986

CASE 654-07, STYLE 5



**COMPLEMENTARY DUAL
GENERAL PURPOSE TRANSISTOR
NPN/PNP SILICON**

MAXIMUM RATINGS

Rating	Symbol	Value		Unit
Collector-Emitter Voltage	V _{CEO}	15		Vdc
Collector-Base Voltage	V _{CBO}	40		Vdc
Emitter-Base Voltage	V _{EBO}	5.0		Vdc
Collector Current — Continuous	I _C	200		mAdc
		One Die	Both Die Equal Power	
Total Device Dissipation @ T _A = 25°C Derate above 25°C	P _D	550 3.14	600 3.42	mW mW/°C
Total Device Dissipation @ T _C = 25°C Derate above 25°C	P _D	1.4 8.0	2.0 11.4	Watts mW/°C
Operating and Storage Junction Temperature Range	T _J , T _{stg}	-65 to +200		°C

THERMAL CHARACTERISTICS

Characteristic	Symbol	One Die	Both Die Equal Power	Unit
Thermal Resistance, Junction to Case	R _{θJC}	125	87.5	°C/W
Thermal Resistance, Junction to Ambient	R _{θJA(1)}	319	292	°C/W
	Junction to Ambient	Junction to Case		
Coupling Factors		83	40	%

(1) R_{θJA} is measured with the device soldered into a typical printed circuit board.

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit
OFF CHARACTERISTICS					
Collector-Emitter Breakdown Voltage(2) (I _C = 10 mAdc, I _B = 0)	V _{(BR)CEO}	15	—	—	Vdc
Collector-Base Breakdown Voltage (I _C = 10 μAdc, I _E = 0)	V _{(BR)CBO}	40	—	—	Vdc
Emitter-Base Breakdown Voltage (I _E = 10 μAdc, I _C = 0)	V _{(BR)EBO}	5.0	—	—	Vdc
Collector Cutoff Current (V _{CB} = 20 Vdc, I _E = 0) (V _{CB} = 20 Vdc, I _E = 0, T _A = 150°C)	I _{CBO}	—	—	25 30	nAdc μAdc

ON CHARACTERISTICS

DC Current Gain (I _C = 10 mAdc, V _{CE} = 10 Vdc)	h _{FE}	25	—	—	—
Collector-Emitter Saturation Voltage (I _C = 10 mAdc, I _B = 1.0 mAdc) (I _C = 50 mAdc, I _B = 10 mAdc)	V _{CE(sat)}	—	—	0.3 0.5	Vdc
Base-Emitter Saturation Voltage (I _C = 10 mAdc, I _B = 1.0 mAdc)	V _{BE(sat)}	—	—	0.9	Vdc

SMALL-SIGNAL CHARACTERISTICS

Current-Gain — Bandwidth Product (I _C = 20 mAdc, V _{CE} = 20 Vdc, f = 100 MHz)	f _T	200	320	—	MHz
Output Capacitance (V _{CB} = 10 Vdc, I _E = 0, f = 100 kHz)	C _{obo}	—	—	4.0	pF

(2) Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2.0%.

MAXIMUM RATINGS

Rating	Symbol	Value		Unit
Collector-Emitter Voltage	V _{CEO}	30		Vdc
Collector-Base Voltage	V _{CBO}	60		Vdc
Emitter-Base Voltage	V _{EBO}	5.0		Vdc
Collector Current — Continuous	I _C	500		mAdc
		One Die	All Die Equal Power	
Total Device Dissipation @ T _A = 25°C MD1121, MD1122 MD1120F, MD1121F, MD1122F MQ1120	P _D	575 350 400	625 400 600	mW
Derate above 25°C MD1121, MD1122 MD1120F, MD1121F, MD1122F MQ1120		3.29 2.0 2.28	3.57 2.28 3.42	mW/°C
Total Device Dissipation @ T _C = 25°C MD1120, MD1121, MD1122 MD1120F, MD1121F, MD1122F MQ1120	P _D	1.8 1.0 0.9	2.5 2.0 3.6	Watts
Derate above 25°C MD1120, MD1121, MD1122 MD1120F, MD1121F, MD1122F MQ1120		10.3 5.71 5.13	14.3 11.4 20.5	mW/°C
Operating and Storage Junction Temperature Range	T _J , T _{Stg}	-65 to +200		°C

THERMAL CHARACTERISTICS

Characteristic	Symbol	One Die	All Die Equal Power	Unit
Thermal Resistance, Junction to Case MD1121, MD1122 MD1120F, MD1121F, MD1122F MQ1120	R _{θJC}	97 175 195	70 87.5 48.8	°C/W
Thermal Resistance, Junction to Ambient MD1121, MD1122 MD1120F, MD1121F, MD1122F MQ1120	R _{θJA(1)}	304 500 438	280 438 292	°C/W
	Junction to Ambient	Junction to Case		Unit
Coupling Factors MD1121, MD1122 MD1120F, MD1121F, MD1122F MQ1120 (Q1-Q2) (Q1-Q3 or Q1-Q4)		84 75 57 55	44 0 0 0	%

(1) R_{θJA} is measured with the device soldered into a typical printed circuit board.

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit
OFF CHARACTERISTICS					
Collector-Emitter Breakdown Voltage(2) (I _C = 10 mAdc, I _E = 0)	V _{(BR)CEO}	30	—	—	Vdc
Collector-Base Breakdown Voltage (I _C = 10 μAdc, I _E = 0)	V _{(BR)CBO}	60	—	—	Vdc
Emitter-Base Breakdown Voltage (I _E = 10 μAdc, I _C = 0)	V _{(BR)EBO}	5.0	—	—	Vdc
Collector Cutoff Current (V _{CB} = 50 Vdc, I _E = 0) (V _{CB} = 50 Vdc, I _E = 0, T _A = 150°C)	I _{CBO}	— —	— —	10 10	nAdc μAdc
Emitter Cutoff Current (V _{EB} = 3.0 Vdc, I _C = 0)	I _{EBO}	—	—	10	nAdc

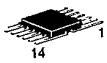
1-29-21
**MD1120F
MD1121,F
MD1122,F
MQ1120**



MD1121, MD1122
CASE 654-07, STYLE 1



MD1120F
CASE 610A-04, STYLE 1



MQ1120
CASE 607-04, STYLE 1

**DUAL
AMPLIFIER TRANSISTOR
NPN SILICON**

Refer to MD2218,A for graphs.

ELECTRICAL CHARACTERISTICS (continued) ($T_A = 25^\circ\text{C}$ unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit
ON CHARACTERISTICS					
DC Current Gain(2) ($I_C = 10 \mu\text{A}/\text{dc}$, $V_{CE} = 10 \text{ Vdc}$) ($I_C = 100 \mu\text{A}/\text{dc}$, $V_{CE} = 10 \text{ Vdc}$) ($I_C = 1.0 \text{ mA}/\text{dc}$, $V_{CE} = 10 \text{ Vdc}$) ($I_C = 10 \text{ mA}/\text{dc}$, $V_{CE} = 10 \text{ Vdc}$)	h_{FE}	20 30 40 50	40 50 60 65	100 120 160 200	—
Collector-Emitter Saturation Voltage ($I_C = 10 \text{ mA}/\text{dc}$, $I_B = 1.0 \text{ mA}/\text{dc}$)	$V_{CE(\text{sat})}$	—	80	100	mVdc
Base-Emitter Saturation Voltage ($I_C = 10 \text{ mA}/\text{dc}$, $I_B = 1.0 \text{ mA}/\text{dc}$)	$V_{BE(\text{sat})}$	—	700	850	mVdc
SMALL-SIGNAL CHARACTERISTICS					
Current-Gain — Bandwidth Product(2) ($I_C = 20 \text{ mA}/\text{dc}$, $V_{CE} = 20 \text{ Vdc}$, $f = 100 \text{ MHz}$)	f_T	200	250	—	MHz
Output Capacitance ($V_{CB} = 10 \text{ Vdc}$, $I_E = 0$, $f = 100 \text{ kHz}$)	C_{obo}	—	3.5	8.0	pF
MATCHING CHARACTERISTICS					
DC Current Gain Ratio(3) ($I_C = 100 \mu\text{A}/\text{dc}$, $V_{CE} = 10 \text{ Vdc}$) ($I_C = 1.0 \text{ mA}/\text{dc}$, $V_{CE} = 10 \text{ Vdc}$)	All Devices MD1122, MD1122F	h_{FE1}/h_{FE2}	0.8 0.9	— —	1.0 1.0
Base-Emitter Voltage Differential ($I_C = 100 \mu\text{A}/\text{dc}$, $V_{CE} = 10 \text{ Vdc}$) ($I_C = 1.0 \text{ mA}/\text{dc}$, $V_{CE} = 10 \text{ Vdc}$)	All Devices MD1122, MD1122F	$ V_{BE1}-V_{BE2} $	— —	— —	10 5.0
Base-Emitter Voltage Differential Change Due to Temperature — MD1121, MD1122 ($I_C = 100 \mu\text{A}/\text{dc}$, $V_{CE} = 10 \text{ Vdc}$, $T_A = -55$ to $+25^\circ\text{C}$) ($I_C = 100 \mu\text{A}/\text{dc}$, $V_{CE} = 10 \text{ Vdc}$, $T_A = +25$ to $+125^\circ\text{C}$)		$\Delta(V_{BE1}-V_{BE2})$	— —	— —	0.8 1.0

(2) Pulse Test: Pulse Width $\leq 300 \mu\text{s}$, Duty Cycle $\leq 2.0\%$.

(3) The lowest h_{FE} reading is taken as h_{FE1} for this ratio.

MD1123

MD1130

MAXIMUM RATINGS

Rating	Symbol	Value		Unit
Collector-Emitter Voltage	V_{CEO}	40		Vdc
Collector-Base Voltage	V_{CBO}	60		Vdc
Emitter-Base Voltage	V_{EBO}	5.0		Vdc
Collector Current — Continuous	I_C	200		mAdc
		One Die	All Die	
Total Device Dissipation @ $T_A = 25^\circ\text{C}$ Derate above 25°C	P_D	575 3.29	625 3.57	mW mW/ $^\circ\text{C}$
Total Device Dissipation @ $T_C = 25^\circ\text{C}$ Derate above 25°C	P_D	1.8 10.3	2.5 14.3	Watts mW/ $^\circ\text{C}$
Operating and Storage Junction Temperature Range	T_J, T_{stg}	-65 to +200		$^\circ\text{C}$

THERMAL CHARACTERISTICS

Characteristic	Symbol	One Die	All Die Equal Power	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$	97	70	$^\circ\text{C/W}$
Thermal Resistance, Junction to Ambient	$R_{\theta JA}(1)$	304	280	$^\circ\text{C/W}$
	Junction to Ambient	Junction to Case		
Coupling Factors		84	44	%

(1) $R_{\theta JA}$ is measured with the device soldered into a typical printed circuit board.

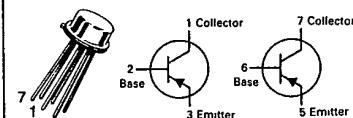
ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit
OFF CHARACTERISTICS					
Collector-Emitter Breakdown Voltage(2) ($I_C = 10 \text{ mAdc}, I_B = 0$)	$V_{(BR)CEO}$	40	—	—	Vdc
Collector-Base Breakdown Voltage ($I_C = 10 \mu\text{Adc}, I_E = 0$)	$V_{(BR)CBO}$	60	—	—	Vdc
Emitter-Base Breakdown Voltage ($I_E = 10 \mu\text{Adc}, I_C = 0$)	$V_{(BR)EBO}$	5.0	—	—	Vdc
Collector Cutoff Current ($V_{CB} = 50 \text{ Vdc}, I_E = 0$) ($V_{CB} = 50 \text{ Vdc}, I_E = 0, T_A = 150^\circ\text{C}$)	I_{CBO}	—	—	10	$n\text{Adc}$ μAdc
Emitter Cutoff Current ($V_{BE} = 3.0 \text{ Vdc}, I_C = 0$)	I_{EBO}	—	—	10	$n\text{Adc}$

ON CHARACTERISTICS

DC Current Gain(2) ($I_C = 10 \mu\text{Adc}, V_{CE} = 10 \text{ Vdc}$)	MD1130	h_{FE}	60	100	—	—
($I_C = 100 \mu\text{Adc}, V_{CE} = 10 \text{ Vdc}$)	MD1123		30	80	120	
($I_C = 1.0 \text{ mA}, V_{CE} = 10 \text{ Vdc}$)	MD1130		100	180	—	
($I_C = 10 \text{ mA}, V_{CE} = 10 \text{ Vdc}$)	MD1123 MD1130		50 100	75 150	200 —	

CASE 654-07, STYLE 1



DUAL AMPLIFIER TRANSISTOR

PNP SILICON

ELECTRICAL CHARACTERISTICS (continued) ($T_A = 25^\circ\text{C}$ unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit
Collector-Emitter Saturation Voltage ($I_C = 10 \text{ mA}_\text{dc}$, $I_B = 1.0 \text{ mA}_\text{dc}$)	$V_{CE(\text{sat})}$	—	0.18	0.25	Vdc
Base-Emitter Saturation Voltage ($I_C = 10 \text{ mA}_\text{dc}$, $I_B = 1.0 \text{ mA}_\text{dc}$)	$V_{BE(\text{sat})}$	—	0.8	0.9	Vdc

SMALL-SIGNAL CHARACTERISTICS

Current-Gain — Bandwidth Product ($I_C = 20 \text{ mA}_\text{dc}$, $V_{CE} = 20 \text{ Vdc}$, $f = 100 \text{ MHz}$)	MD1123 MD1130	f_T	250 200	600 550	— —	MHz
Output Capacitance ($V_{CB} = 10 \text{ Vdc}$, $I_E = 0$, $f = 100 \text{ kHz}$)	Cobo	—	3.5	4.0	pF	

MATCHING CHARACTERISTICS

DC Current Gain Ratio(3) ($I_C = 100 \mu\text{A}_\text{dc}$, $V_{CE} = 10 \text{ Vdc}$)	MD1123 MD1130	h_{FE1}/h_{FE2}	0.8 0.9	— —	1.0 1.0	—
Base-Emitter Voltage Differential ($I_C = 100 \mu\text{A}_\text{dc}$, $V_{CE} = 10 \text{ Vdc}$) ($I_C = 1.0 \text{ mA}_\text{dc}$, $V_{CE} = 10 \text{ Vdc}$)	MD1123 MD1130	$ V_{BE1}-V_{BE2} $	— —	— —	10 5.0	mVdc
Base-Emitter Voltage Differential Change Due to Temperature — MD1121, MD1122 ($I_C = 100 \mu\text{A}_\text{dc}$, $V_{CE} = 10 \text{ Vdc}$, $T_A = +25 \text{ to } +125^\circ\text{C}$)	MD1130	$A V_{BE1}-V_{BE2} $	— —	— —	10	mVdc

(2) Pulse Test: Pulse Width $\leq 300 \mu\text{s}$, Duty Cycle $\leq 2.0\%$.

(3) The lowest h_{FE} reading is taken as h_{FE1} for this ratio.